

V _{CES}	650V
I _{C(100°C)}	16A
V _{CE(sat) (Typ.)}	1.6V@I _C =25A
P _D	59W

Features

- 1) Low Collector Emitter Saturation Voltage
- 2) High Speed Switching
- 3) Low Switching Loss & Soft Switching
- 4) Built in Very Fast & Soft Recovery FRD (RFN Series)
- 5) Pb free Lead Plating ; RoHS Compliant

Applications

PFC

UPS

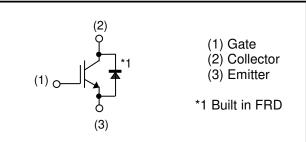
Power Conditioner

IH

Outline



Inner Circuit



Packaging Specifications

	Packaging	Tube
	Reel Size (mm)	-
Type	Tape Width (mm)	-
Туре	Basic Ordering Unit (pcs)	450
	Packing Code	C11
	Marking	RGTH50TK65D

●Absolute Maximum Ratings (at T_C = 25°C unless otherwise specified)

0,00			,	
Parameter		Symbol	Value	Unit
Collector - Emitter Voltage		V _{CES}	650	V
Gate - Emitter Voltage		V _{GES}	±30	V
Collector Current	$T_{\rm C} = 25^{\circ}{\rm C}$	Ι _C	26	А
Collector Current	T _C = 100°C	Ι _C	16	А
Pulsed Collector Current		I _{CP} *1	100	А
Diada Farward Current	$T_{\rm C} = 25^{\circ}{\rm C}$	I _F	26	А
Diode Forward Current	T _C = 100°C	l _F	15	А
Diode Pulsed Forward Current		I _{FP} ^{*1}	100	А
Dower Dissinction	$T_{\rm C} = 25^{\circ}{\rm C}$	P _D	59	W
Power Dissipation	T _C = 100°C	P _D	29	W
Operating Junction Temperatu	re	T _j	-40 to +175	°C
Storage Temperature		T _{stg}	-55 to +175	°C
*1 Pulse width limited by T		-	-	

*1 Pulse width limited by T_{jmax.}

Thermal Resistance

Parameter	Symbol	Values			Unit
Parameter	Symbol	Min.	Тур.	Max.	Unit
Thermal Resistance IGBT Junction - Case	$R_{\theta(j\text{-}c)}$	-	-	2.51	°C/W
Thermal Resistance Diode Junction - Case	$R_{\theta(j\text{-}c)}$	-	-	3.93	°C/W

•IGBT Electrical Characteristics (at $T_j = 25^{\circ}C$ unless otherwise specified)

Parameter	Symbol	Conditions	Values			Unit
Farameter	Symbol	Conditions	Min.	Тур.	Max.	Unit
Collector - Emitter Breakdown Voltage	BV_{CES}	I _C = 10μΑ, V _{GE} = 0V	650	-	-	V
Collector Cut - off Current	I _{CES}	V _{CE} = 650V, V _{GE} = 0V	-	-	10	μA
Gate - Emitter Leakage Current	I _{GES}	$V_{GE} = \pm 30V, V_{CE} = 0V$	-	-	±200	nA
Gate - Emitter Threshold Voltage	$V_{GE(th)}$	V _{CE} = 5V, I _C = 17.5mA	4.5	5.5	6.5	V
Collector - Emitter Saturation Voltage	V _{CE(sat)}	$I_{C} = 25A, V_{GE} = 15V$ $T_{j} = 25^{\circ}C$ $T_{j} = 175^{\circ}C$	-	1.6 2.1	2.1 -	V

•IGBT Electrical Characteristics (at $T_j = 25^{\circ}C$ unless otherwise specified)

Deremeter	Cumbal	Conditions	Values			Linsit
Parameter	Symbol	Conditions	Min.	Тур.	Max.	Unit
Input Capacitance	C _{ies}	V _{CE} = 30V	-	1410	-	
Output Capacitance	C _{oes}	$V_{GE} = 0V$	-	57	-	pF
Reverse Transfer Capacitance	C _{res}	f = 1MHz	-	22	-	
Total Gate Charge	Q_g	V _{CE} = 300V	-	49	-	
Gate - Emitter Charge	Q_{ge}	I _C = 25A	-	15	-	nC
Gate - Collector Charge	Q_{gc}	V _{GE} = 15V	-	19	-	
Turn - on Delay Time	t _{d(on)}	$I_{C} = 25A, V_{CC} = 400V$	-	27	-	
Rise Time	t _r	$V_{GE} = 15V, R_G = 10\Omega$	-	38	-	20
Turn - off Delay Time	t _{d(off)}	$T_j = 25^{\circ}C$	-	94	-	ns
Fall Time	t _f	Inductive Load	-	50	-	
Turn - on Delay Time	t _{d(on)}	$I_{\rm C} = 25 {\rm A}, \ V_{\rm CC} = 400 {\rm V}$	-	27	-	
Rise Time	t _r	$V_{GE} = 15V, R_G = 10\Omega$	-	38	-	
Turn - off Delay Time	$t_{d(off)}$	T _j = 175°C	-	107	-	ns
Fall Time	t _f	Inductive Load	-	65	-	
		$I_{\rm C} = 100$ A, $V_{\rm CC} = 520$ V		-	-	
Reverse Bias Safe Operating Area	RBSOA	$V_{P} = 650V, V_{GE} = 15V$	FU	LL SQUA	RE	-
		$R_{G} = 60\Omega, T_{j} = 175^{\circ}C$				

•FRD Electrical Characteristics (at $T_j = 25^{\circ}C$ unless otherwise specified)

Devemeter	Symbol	Conditions	Values			Unit	
Parameter	Symbol	Conditions	Min.	Тур.	Max.	Unit	
Diode Forward Voltage	V _F	$I_F = 20A$ $T_j = 25^{\circ}C$ $T_j = 175^{\circ}C$	-	1.45 1.25	1.9 -	V	
Diode Reverse Recovery Time	t _{rr}	I _F = 20A	-	58	-	ns	
Diode Peak Reverse Recovery Current	I _{rr}	V _{CC} = 400V di _F /dt = 200A/µs	-	6.3	-	А	
Diode Reverse Recovery Charge	Q _{rr}	T _j = 25°C	-	0.20	-	μC	
Diode Reverse Recovery Time	t _{rr}	I _F = 20A	-	256	-	ns	
Diode Peak Reverse Recovery Current	I _{rr}	V _{CC} = 400V di _F /dt = 200A/µs	-	10.4	-	А	
Diode Reverse Recovery Charge	Q _{rr}	T _j = 175°C	-	1.35	-	μC	

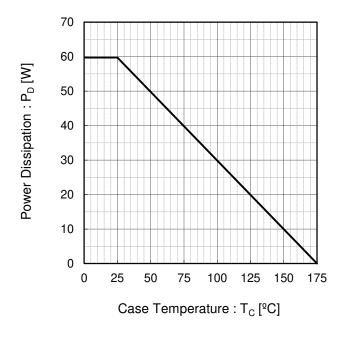


Fig.1 Power Dissipation vs. Case Temperature

Fig.2 Collector Current vs. Case Temperature

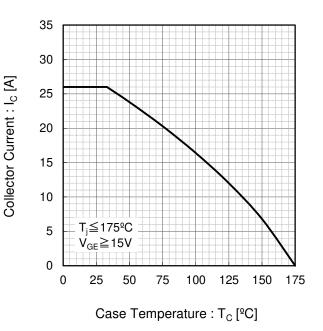
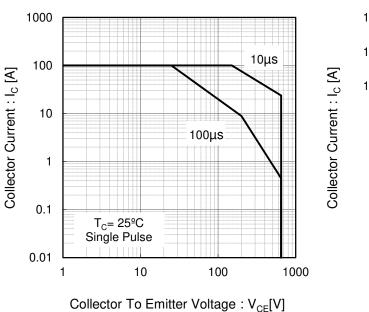
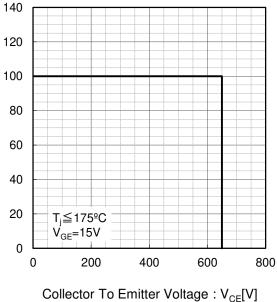


Fig.3 Forward Bias Safe Operating Area

Fig.4 Reverse Bias Safe Operating Area





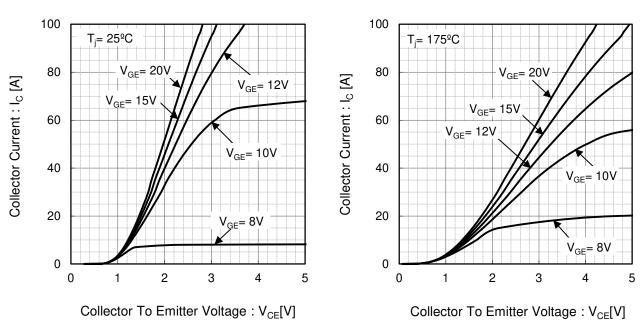
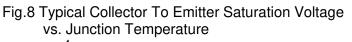
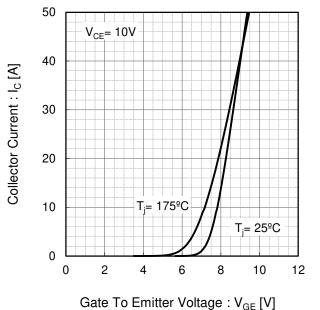


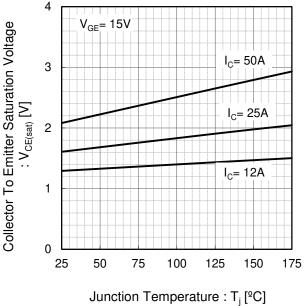
Fig.5 Typical Output Characteristics

Fig.6 Typical Output Characteristics

Fig.7 Typical Transfer Characteristics







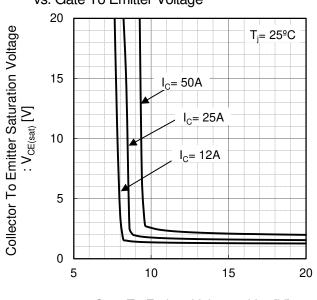
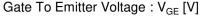


Fig.9 Typical Collector To Emitter Saturation Voltage vs. Gate To Emitter Voltage

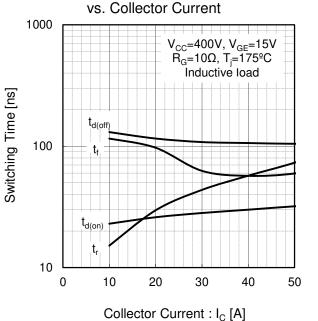


20 Collector To Emitter Saturation Voltage T_i= 175⁰C 15 $I_{\rm C} = 50A$: V_{CE(sat)} [V] 10 $I_{c} = 25A$ $I_{C}= 12A$ 5 0 5 10 15 20

Fig.10 Typical Collector To Emitter Saturation Voltage

vs. Gate To Emitter Voltage

Gate To Emitter Voltage : V_{GE} [V]



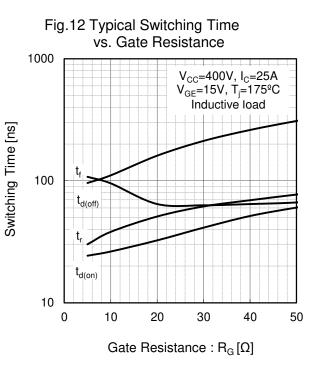
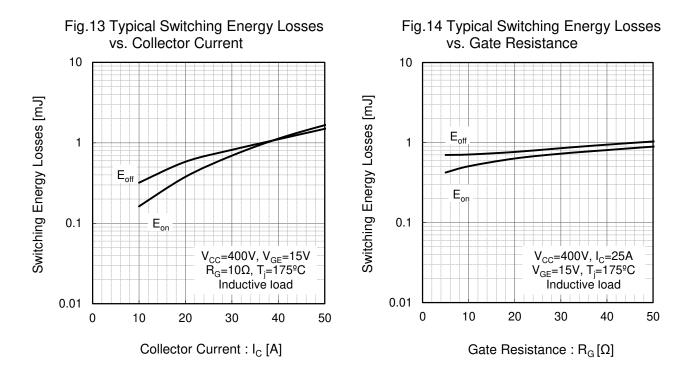


Fig.11 Typical Switching Time vs. Collector Current



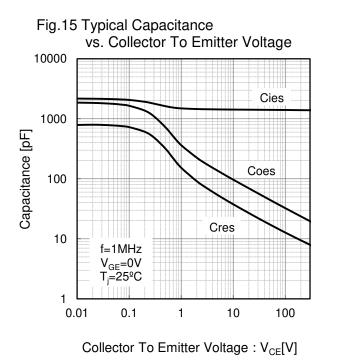
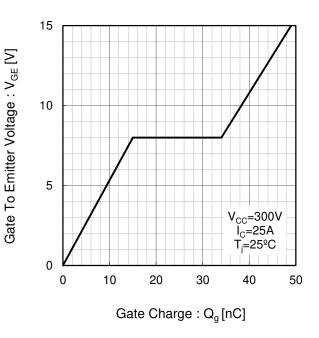


Fig.16 Typical Gate Charge



© 2016 ROHM Co., Ltd. All rights reserved.

www.rohm.com

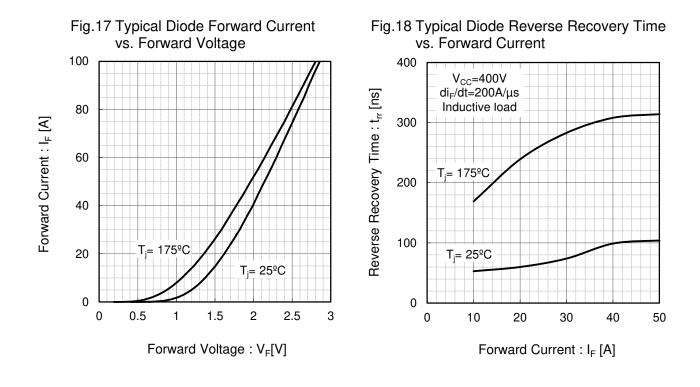


Fig.19 Typical Diode Reverse Recovery Current vs. Forward Current

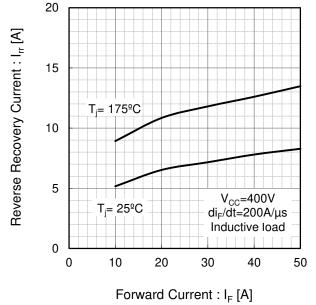
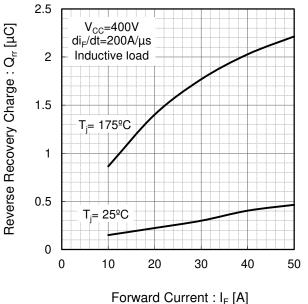


Fig.20 Typical Diode Reverse Recovery Charge vs. Forward Current



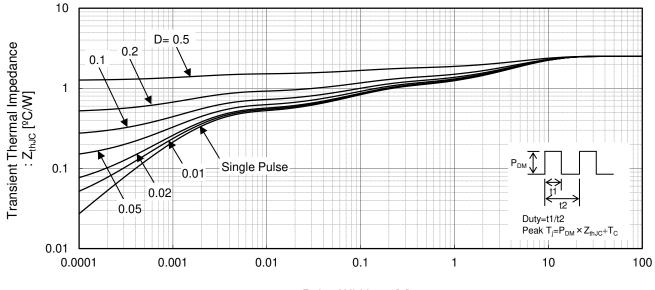
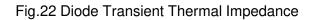
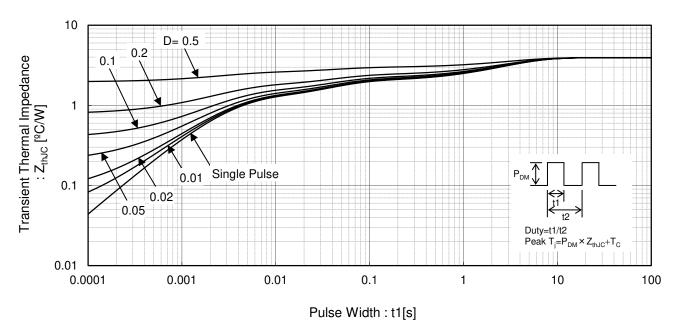


Fig.21 IGBT Transient Thermal Impedance

Pulse Width : t1[s]





●Inductive Load Switching Circuit and Waveform

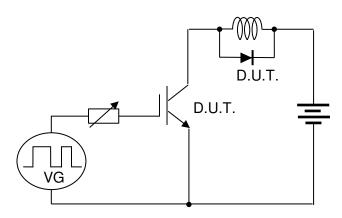


Fig.23 Inductive Load Circuit

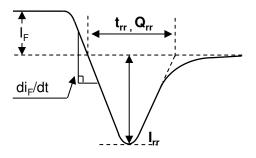
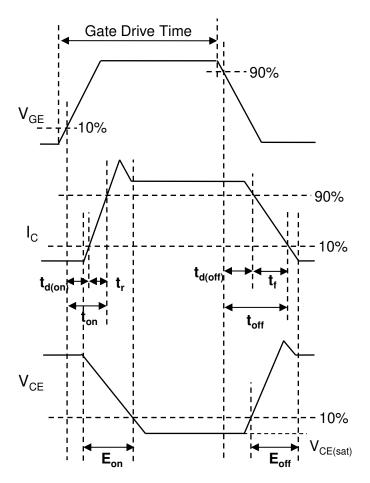
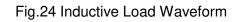


Fig.25 Diode Reverce Recovery Waveform





	Notes
1)	The information contained herein is subject to change without notice.
2)	Before you use our Products, please contact our sales representative and verify the latest specifica- tions :
3)	Although ROHM is continuously working to improve product reliability and quality, semicon- ductors can break down and malfunction due to various factors. Therefore, in order to prevent personal injury or fire arising from failure, please take safety measures such as complying with the derating characteristics, implementing redundant and fire prevention designs, and utilizing backups and fail-safe procedures. ROHM shall have no responsibility for any damages arising out of the use of our Poducts beyond the rating specified by ROHM.
4)	Examples of application circuits, circuit constants and any other information contained herein are provided only to illustrate the standard usage and operations of the Products. The periphera conditions must be taken into account when designing circuits for mass production.
5)	The technical information specified herein is intended only to show the typical functions of and examples of application circuits for the Products. ROHM does not grant you, explicitly or implicitly any license to use or exercise intellectual property or other rights held by ROHM or any other parties. ROHM shall have no responsibility whatsoever for any dispute arising out of the use of such technical information.
6)	The Products are intended for use in general electronic equipment (i.e. AV/OA devices, communication, consumer systems, gaming/entertainment sets) as well as the applications indicated in this document.
7)	The Products specified in this document are not designed to be radiation tolerant.
8)	For use of our Products in applications requiring a high degree of reliability (as exemplified below), please contact and consult with a ROHM representative : transportation equipment (i.e cars, ships, trains), primary communication equipment, traffic lights, fire/crime prevention, safety equipment, medical systems, servers, solar cells, and power transmission systems.
9)	Do not use our Products in applications requiring extremely high reliability, such as aerospace equipment, nuclear power control systems, and submarine repeaters.
10)	ROHM shall have no responsibility for any damages or injury arising from non-compliance with the recommended usage conditions and specifications contained herein.
11)	ROHM has used reasonable care to ensur the accuracy of the information contained in this document. However, ROHM does not warrants that such information is error-free, and ROHM shall have no responsibility for any damages arising from any inaccuracy or misprint of such information.
12)	Please use the Products in accordance with any applicable environmental laws and regulations such as the RoHS Directive. For more details, including RoHS compatibility, please contact a ROHM sales office. ROHM shall have no responsibility for any damages or losses resulting non-compliance with any applicable laws or regulations.
13)	When providing our Products and technologies contained in this document to other countries you must abide by the procedures and provisions stipulated in all applicable export laws and regulations, including without limitation the US Export Administration Regulations and the Foreign Exchange and Foreign Trade Act.
14)	This document, in part or in whole, may not be reprinted or reproduced without prior consent o ROHM.



Thank you for your accessing to ROHM product informations. More detail product informations and catalogs are available, please contact us.

ROHM Customer Support System

http://www.rohm.com/contact/